

M270HTN02.2

AU OPTRONICS CORPORATION

(	)	<b>Preliminary Specification</b>
(V	)	Final Specification

Module	27" Color TFT-LCD
Model Name	M270HTN02.2

Customer Date	Approved by	Date
	<u>Howard Lee</u>	<u>Dec 20, 2016</u>
Approved by	Prepared by	Date
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Note: This Specification is subject to change without notice.	AU Optronics	corporation

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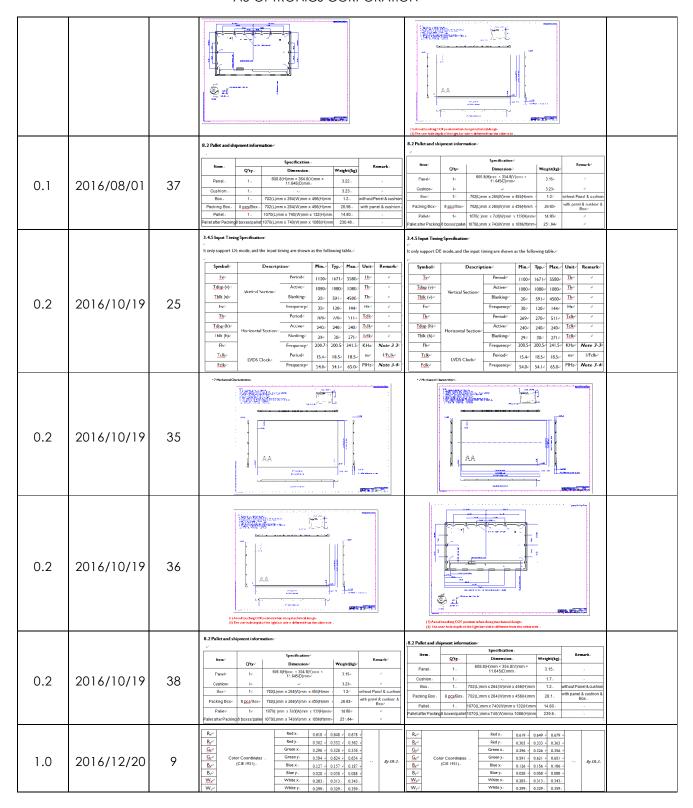
# **Record of Revision**

Version	Date	Page	Old description	New Description	Remark
0.0	2016/602	All		New release	
0.1	2016/08/01	All	document version 0.0	document version 0.1	
0.1	2016/08/01	6	Power Consumption    Power Consumption   (ICD Mydde + Backigh unit)*   (PWat)   TFID (Typ )-	Power Consumption	
0.1	2016/08/01	8	2.3 Optical Characteristics  Test Condition:  3. VDD=12.0V,  Fv=120Hz,ls=100mA,Ta=25°C	2.3 Optical Characteristics  Test Condition:  3. VDD=12.0V,  Fv=120Hz,ls=80mA,Ta=25°C	
0.1	2016/08/01	8	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
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0.1	2016/08/01	24	A. Calopea T bringing by politication:	3.4.5 from Timery Speckscome.  Sometime To Description of the National Part Reliable to Description of the Nati
0.1	2016/08/01	24	Note 3-8: The equation is listed as following. Please don't exceed the above recommended value."   Fit (Min.) = Ficlk (Min.) / Th (Min.); '   Fit (Typ.) = Ficlk (Typ.) / Th (Typ.); '   Fit (Min.) = Ficlk (Min.) / Th (Min.); '   Fit (Min.) = Fick (Min.) × Th (Min.) × Th (Min.)     Fick (Min.) = Fick (Min.) × Th (Min.) × Th (Min.)     Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Max.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Typ.) × Th (Typ.); '   Fick (Min.) = Fick (Min.) × Th (Min.	Note 3-3: Please don't exceed the above recommended value.
0.1	2016/08/01	26	3.5 Power ON/OFF Sequence	3.5 Power ON/OFF Sequence    Symbol
0.1	2016/08/01	29	4.3.1 Abookse Maximum Rating:	Cl.   Abodism Maximum Busing:
0.1	2016/08/01	29	4.3.3 Recommended Operating Conditions   (1=23½)**   Symbol   Description   Prin.   Typ.   Nex.   Usit   Remork   (1=23½)**   bi*   LED Soing Current*   -ii*   Op.   110°   (eA)**   (iii.   Condition   Cond	1.13 Recommended Operating Condition
0.1	2016/08/01	31	Note +1: Vs (Typ.) = V <sub>x</sub> (Typ.) X LED No. (one string):  a. V <sub>x</sub> LED chip forward voltage, V <sub>x</sub> (Min.) = 2.8V, V <sub>x</sub> (Typ.) = 3.05V, V <sub>x</sub> (Max.) = 3.4V··  b. The same equation to calculate Vs/Min), & V <sub>x</sub> (Max.) for respective V <sub>x</sub> (Min.), & V <sub>x</sub> (Max.)	Note 4-f: Vs(1yp) = Vs(1yp) X 1H1 No. (one string):  a. Vs(LED chip broward voltage. Vs (Min.)=2, Vs Vs(1yp,)=3,0V, Vs(Max.)=3,3Vs
_			b. The same edgation to calculate vs(riin.) α vs (riax.) for respective v <sub>s</sub> (riin.) α v <sub>s</sub> (riax.);	b. The same euqation to calculate Vs(Min.) & Vs (Max.) for respective V+ (Min.) & V+(Max.);
0.1	2016/08/01	31	Note 4-4: Definition of life time: $e^i$ a. Brightness of LED becomes to 50% of its original value $e^i$ b. Test condition: $Is = 100$ mA and $25^{\circ}C$ (Room Temperature)	Note 4-4: Definition of life time:   a. Brightness of LED becomes to 50% of its original value  ✓
0.1	2016/08/01	31	Note 1-1: Definition of life time: +/ a. Brightness of LED becomes to 50% of its original value+/	Note 4-4: Definition of life time: ↔  a. Brightness of LED becomes to 50% of its original value.

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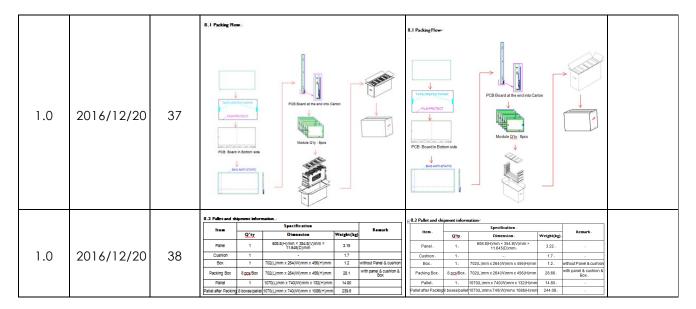


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## 1 Handling Precautions

- 1) Since polarizer is easily damaged, do not touch or press the surface of polorizer with hand.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open or modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) In case a TFT-LCD Module has to be put back into the packing container slot after once it was taken out from the container, do not press the center of the LED lightbar edge. Otherwise the TFT-LCD Module may be damaged.
- 10) Insert or pull out the interface connector, be sure not to rotate nor tilt it of the TFT-LCD Module.
- 11) Do not twist nor bend the TFT -LCD Module even momentary. It should be taken into consideration that no bending/twisting forces are applied to the TFT-LCD Module from outside. Otherwise the TFT-LCD Module may be damaged.
- 12) Please avoid touching COF position while you are doing mechanical design.
- 13) When storing modules as spares for a long time, the following precaution is necessary: Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between  $5^{\circ}$ C and  $35^{\circ}$ C at normal humidity.
- 14) Do not apply the same pattern for a long time, it will enhance relevant defect.

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# 2 General Description

This specification applies to the 27 inch wide Color a-Si TFT-LCD Module M270HTN02.2. The display supports the Full HD - 1920(H) x 1080(V) screen format and 16.7M colors (8bits RGB data input). The input interface is 8 lane V-by-One and this module doesn't contain an driver board for backlight.

## 2.1 Display Characteristics

The following items are characteristics summary on the table under  $25^{\circ}$ C condition:

ITEMS	Unit	SPECIFICATIONS
Screen Diagonal	[mm]	685.65 (27.0")
Active Area	[mm]	597.6 (H) x 336.15 (V)
Pixels H x V	-	1920(x3) x 1080
Pixel Pitch	[um]	311.25 (per one triad) ×311.25
Pixel Arrangement	-	R.G.B. Vertical Stripe
Display Mode	-	TN mode(Twisted Nematic) , Normally White
White Luminance (Center)	[cd/m <sup>2</sup> ]	400 (Typ.)
Contrast Ratio	-	1000 (Typ.)
Response Time	[msec]	5ms (Typ., on/off)
Power Consumption	[Watt]	22.46W (Typ.)
(LCD Module + Backligh unit)		LCD module : PDD (Typ.)=5.16W@ Black pattern,Fv=144Hz Backlight unit : P <sub>BLU</sub> (Typ.) =17.3W @ I <sub>RLED</sub> =80mA
Weight	[Grams]	3220g
Outline Dimension	[mm]	608.8(H) x 354.8(V) x 11.7(D) Typ.
Electrical Interface	-	8 lane V-by-One
Support Color	-	16.7M colors (RGB 8-bits)
Surface Treatment	-	Anti-Glare, 3H
Temperature Range		0 to +50
Operating	[°C]	-20 to +60
Storage (Shipping)	[°C]	20 10 100
RoHS Compliance	-	RoHS Compliance
TCO Compliance	_	NA



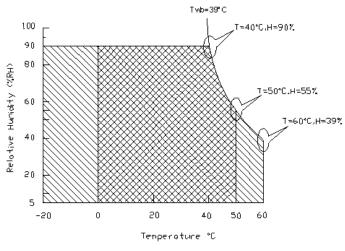
# 2.2 Absolute Maximum Rating of Environment

Permanent damage may occur if exceeding the following maximum rating.

	<u> </u>				
Symbol	Description	Min.	Max.	Unit	Remark
TOP Operating Temperature		0	+50	[°C]	Note 2-1
TGS	Glass surface temperature	0	+65	[°C]	Note 2-1 Function judged
HOP	Operation Humidity	5	90	[%RH]	Note 2-1
TST	Storage Temperature	-20	+60	[°C]	
HST	Storage Humidity	5	90	[%RH]	

Note 2-1: Temperature and relative humidity range are shown as the below figure.

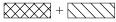
- 1. 90% RH Max ( Ta  $\leq$  39°C)
- 2. Max wet-bulb temperature at 39°C or less. ( Ta  $\leq$  39°C)
- 3. No condensation



Operating Range



Storage Range





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## 2.3 Optical Characteristics

The optical characteristics are measured on the following test condition.

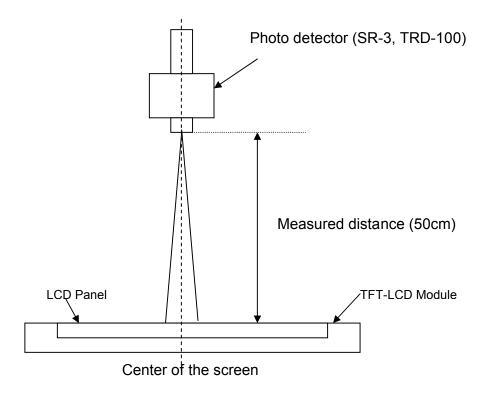
### **Test Condition:**

- 1. Equipment setup: Please refer to Note 2-2.
- 2. Panel Lighting time: 30 minutes
- 3. VDD=12.0V, Fv=120Hz, Is=80mA,  $Ta=25^{\circ}C$

Symbol	Description			Тур.	Max.	Unit	Remark
L <sub>w</sub>	White Luminance (Cent	320	400	-	[cd/m2]	<b>Note 2-2</b> By SR-3	
L <sub>uni</sub>	Luminance Uniformity	(9 points)	75	80	-	[%]	<b>Note 2-3</b> By SR-3
CR	Contrast Ratio (Center	of screen)	600	1000	-	-	<b>Note 2-4</b> By SR-3
$\Theta_{R}$	Horizontal Viewing Angle	Right	75	85	-		
θL	(CR=10)	Left	75	85	-		
Фн	Vertical Viewing Angle	Up	70	80	_		
$\Phi_L$	(CR=10)	Down	70	80	-	[degree]	Note 2-5
$\boldsymbol{\theta}_{R}$	Horizontal Viewing Angle	Right	75	88	-		By SR-3
$\theta_{L}$	(CR=5)	Left	75	88	-	Ī	
$\Phi_{H}$	Vertical Viewing Angle	Up	70	85	-		
$\Phi_L$	(CR=5)	Down	70	85	-		
$T_{R}$		Rising Time	-	3.8	5.5	[msec]	
T <sub>F</sub>	Response Time	Falling Time	-	1.2	2.5		Note 2-6
-		Rising + Falling	-	5	8		By TRD-100
R <sub>x</sub>		Red x	0.619	0.649	0.679		
Ry		Red y	0.303	0.333	0.363		
G <sub>x</sub>		Green x	0.296	0.326	0.356		
Gy	Color Coordinates	Green y	0.591	0.621	0.651	_	0.000
B <sub>x</sub>	(CIE 1931)	Blue x	0.126	0.156	0.186		By SR-3
Ву		Blue y	0.028	0.058	0.088		
$W_{x}$		White x	0.283	0.313	0.343		
$W_{y}$		White y	0.299	0.329	0.359		
	NTSC coverage ratio			72		[%]	By SR-3
СТ	Crosstalk		-	-	1.5	[%]	<b>Note 2-7</b> By SR-3
F <sub>dB</sub>	Flicker (Center of s	creen)	-	-	-20	[dB]	<b>Note 2-8</b> By SR-3

Note 2-2: Equipment setup:



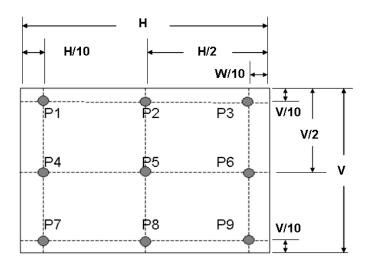


Note 2-3: Luminance Uniformity Measurement

### **Definition:**

 $Luminance\ Uniformity = \frac{Minimum\ Luminance\ of\ 9\ Points\ (P1 \sim P9)}{Maximum\ Luminance\ of\ 9\ Points\ (P1 \sim P9)}$ 

a.Test pattern: White Pattern



Note 2-4: Contrast Ratio Measurement



### **Definition:**

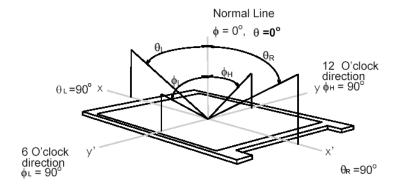
 $Contrast Ratio = \frac{Luminance of White pattern}{Luminance of Black pattern}$ 

a. Measured position: Center of screen (P5) & perpendicular to the screen  $(\theta=\Phi=0^{\circ})$ 

Note 2-5: Viewing angle measurement

**Definition:** The angle at which the contrast ratio is greater than 10 & 5.

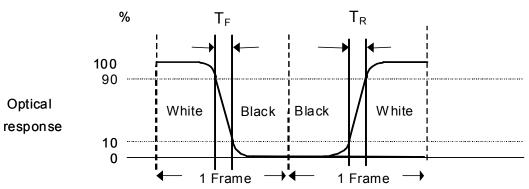
a. Horizontal view angle: Divide to left & right ( $\theta_L \& \theta_R$ ) Vertical view angle: Divide to up & down ( $\Phi_H \& \Phi_L$ )



Note 2-6: Response time measurement



The output signals of photo detector are measured when the input signals are changed from "Black" to "White" (rising time,  $T_R$ ), and from "White" to "Black" (falling time,  $T_F$ ), respectively. The response time is interval between the 10% and 90% of optical response. (Black & White color definition: Please refer section 3.4.3)



Note 2-7: Crosstalk measurement

**Definition:** 

 $CT = Max. (CT_H, CT_V);$ 



Where

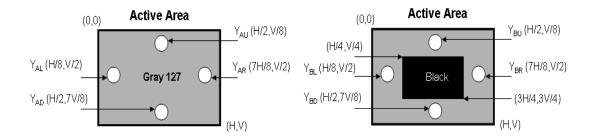
a.Maximum Horizontal Crosstalk:

$$CT_H = Max. ( | Y_{BL} - Y_{AL} | / Y_{AL} \times 100 \%, | Y_{BR} - Y_{AR} | / Y_{AR} \times 100 \%);$$

Maximum Vertical Crosstalk:

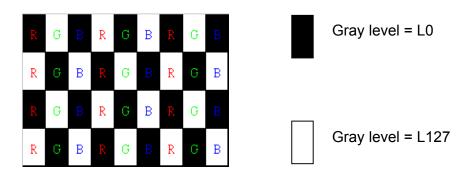
$$CT_V = Max. (| Y_{BU} - Y_{AU} | / Y_{AU} \times 100 \%, | Y_{BD} - Y_{AD} | / Y_{AD} \times 100 \%);$$

b.  $Y_{AU}$ ,  $Y_{AD}$ ,  $Y_{AL}$ ,  $Y_{AR}$  = Luminance of measured location without Black pattern  $Y_{BU}$ ,  $Y_{BD}$ ,  $Y_{BL}$ ,  $Y_{BR}$  = Luminance of measured location with Black pattern



Note 2-8: Flicker measurement

a.Test pattern: It is listed as following.



R: Red, G: Green, B:Blue

b. Measured position: Center of screen (P5) & perpendicular to the screen  $(\theta=\Phi=0^{\circ})$ 



### 2.4 Mechanical Characteristics

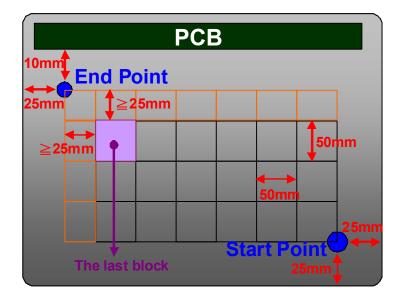
Symbol	Description	Min.	Max.	Unit	Remark
P <sub>bc</sub>	Backside Compression	2.5	-	[Kgf]	Note 2-9

### Note 2-9: Test Method:

The point is at a distance from right-downside 25mm x 25mm defined as the Start Point of Measure Points, and the point is at a distance 25mm from left-side & around 10mm from PCB defined as the End Point.

Align 50mm x 50mm block from Start Point on the Bezel Back, and the corners of each block are Measure Points.

If the distance from the last block to each side of the End Point  $\geq$  25mm, add other blocks to make sure that most area of Bezel Back can be measured.

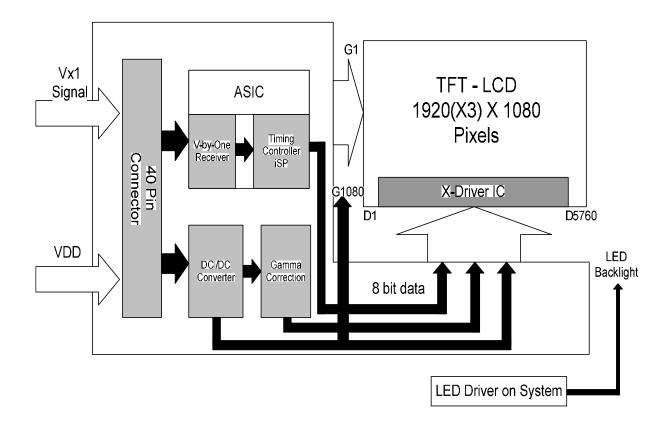




### 3 TFT-LCD Module

### 3.1 Block Diagram

The following shows the block diagram of the 27 inch Color TFT-LCD Module.





# 3.2 Interface Connection

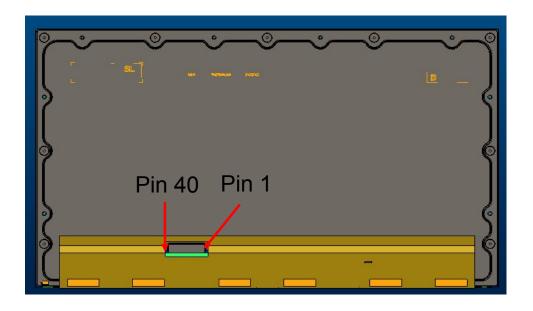
# 3.2.1 Connector Type

TFT-LCD Connector	Manufacturer	STARCONN
TF 1-LCD Connector	Part Number	115F40-R000RA-M3
Mating Connector	Manufacturer	JAE
Wating Connector	Part Number	FI-NX40HL (Locked Type)

# 3.2.2 Connector Pin Assignment

PIN#	Symbol	Description	Remark
1	TxP7	Positive V-by-One lane 7	
2	TxN7	Negative V-by-One lane 7	
3	GND	Ground	
4	TxP6	Positive V-by-One lane 6	
5	TxN6	Negative V-by-One lane 6	
6	GND	Ground	
7	TxP5	Positive V-by-One lane 5	
8	TxN5	Negative V-by-One lane 5	
9	GND	Ground	
10	TxP4	Positive V-by-One lane 4	
11	TxN4	Negative V-by-One lane 4	
12	GND	Ground	
13	TxP3	Positive V-by-One lane 3	
14	TxN3	Negative V-by-One lane 3	
15	GND	Ground	
16	TxP2	Positive V-by-One lane 2	
17	TxN2	Negative V-by-One lane 2	
18	GND	Ground	
19	TxP1	Positive V-by-One lane 1	
20	TxN1	Negative V-by-One lane 1	
21	GND	Ground	
22	TxP0	Positive V-by-One lane 0	
23	TxN0	Negative V-by-One lane 0	
24	GND	Ground	
25	LOCKN	V-by-One LOCKN	
26	HTPDN	V-by-One HTPDN	
27	NC	No Connection (for AUO test only. Do not connect)	

28	NC	No Connection (for AUO test only. Do not connect)
29	NC	No Connection (for AUO test only. Do not connect)
30	NC	No Connection (for AUO test only. Do not connect)
31	NC	No Connection (for AUO test only. Do not connect)
32	NC	No Connection (for AUO test only. Do not connect)
33	NC	No Connection (for AUO test only. Do not connect)
34	NC	No Connection (for AUO test only. Do not connect)
35	NC	No Connection (for AUO test only. Do not connect)
36	VIN	Power Supply Input Voltage
37	VIN	Power Supply Input Voltage
38	VIN	Power Supply Input Voltage
39	VIN	Power Supply Input Voltage
40	VIN	Power Supply Input Voltage





### 3.3 Electrical Characteristics

### 3.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

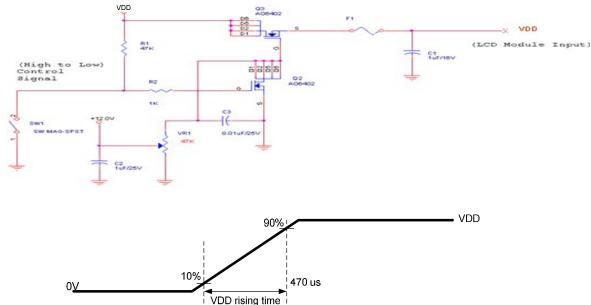
Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	14.0	[Volt	Ta=25°C

3.3.2 Recommended Operating Condition

O.O.Z NCC	23.2 Recommended Operating Condition												
Symbol	Description	Min	Тур	Max	Unit	Remark							
VDD	Power supply Input voltage	10.8	12.0	13.2	[Volt]								
IDD	Power supply Input Current (RMS)	-	0.43	0.52	[A]	VDD= 12.0V, Black Pattern, Fv=144Hz							
PDD	VDD Power Consumption	-	5.16	6.24	[Watt]	VDD= 12.0V, Black Pattern, Fv=144Hz							
IRush	Inrush Current	-	-	3.5	[A]	Note 3-1							
VDDrp	Allowable VDD Ripple Voltage	-	-	500	[mV]	VDD= 12.0V, Black Pattern, Fv=144Hz							

Note 3-1: Inrush Current measurement:





The duration of VDD rising time: 470us.

\_\_\_\_\_

## 3.4 Signal Characteristics

### 3.4.1 LCD Pixel Format

	]	Lane( ↓	)	Ι	.ane	1	1	Lane:	2	]	Lane3	3					]	Lane∠ ↓	!	]	Lane:	5	Ι	Lane6	5	Ι	Lane	7				
		1			2			3			4		•••		960			961			962			963		(	964		•••	1	1920	
1	R	G	В	R	G	В	R	G	В	R	G	В	•••	R	G	В	R	G	В	R	G	В	R	G	В	R	G	В	•••	R	G	В
		•			*			•			*		•		•			•			•			•			•				•	
					•			•			•		•		•									•			•					
																								_			_					
1080	R	G	В	R	G	В	R	G	В	R	G	В	•••	R	G	В	R	G	В	R	G	В	R	G	В	R	G	В	•••	R	G	В

# Note 3-2: The module use 8 Lanes V-by-One interface.

Lane0: 1+4n pixel Lane1: 2+4n pixel Lane2: 3+4n pixel Lane3: 4+4n pixel Lane4: 961+4n pixel Lane5: 962+4n pixel Lane6: 963+4n pixel Lane7: 964+4n pixel

n=0~239



Mode	Packer Unpacke	•	24bpp RGB
		D[0]	R[0]
		D[1]	R[1]
		D[2]	R[2]
	Byte0	D[3]	R[3]
	Бутео	D[4]	R[4]
		D[5]	R[5]
		D[6]	R[6]
		D[7]	R[7]
		D[8]	G[0]
43		D[9]	G[1]
po		D[10]	G[2]
mc	Byte1	D[11]	G[3]
3byte mode	БУІСТ	D[12]	G[4]
3b)		D[13]	G[5]
		D[14]	G[6]
		D[15]	G[7]
		D[16]	B[O]
		D[17]	B[1]
		D[18]	B[2]
	Byto2	D[19]	B[3]
	Byte2	D[20]	B[4]
		D[21]	B[5]
		D[22]	B[6]
		D[23]	B[7]

# 3.4.3 Color versus Input Data

The following table is for color versus input data (8bit). The higher the gray level, the brighter the color.

	Color Input Data																									
Color	Gray Level	RED data ( <b>MSB</b> :R7, <b>LSB</b> :R0)						GREEN data (MSB:G7, LSB:G0)						BLUE data (MSB:B7, LSB:B0)						Remark						
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	В7	В6	B5	B4	ВЗ	В2	B1	В0	
Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray 127	-	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Red	:	• • •	• • •	:	:	:	• • •	::	:	:	:	:	:		:	:	:	:	:	:	:	:	:	:	:	
	L255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Green	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
	Ш	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Blue	:		:	:	:	:		:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	

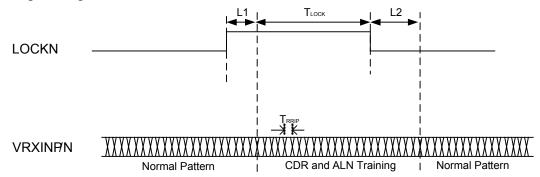


# 3.4.4 V-by-One Specification

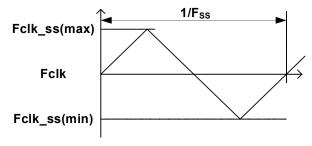
	Item	Symbol	Min.	Тур.	Max	Unit	Note
	VRXINP/N input each bit Period	T <sub>RRIP</sub>	512		617	ps	
	Receiver Clock : Spread Spectrum Modulation range	Fclk_ss	Fclk -0.5%		Fclk +0.5%	MHz	2
	Receiver Clock : Spread Spectrum Modulation frequency	Fss		30		KHz	2
	CDR training pattern time	TLOCK			1	ms	1
	Latency from LOCKN 'HIGH' to clock training pattern	L1	0	-		US	1
	Latency from LOCKN 'LOW' to normal 8b10b data	L2			10	ms	1
	CML Differential Input High Threshold	$V_{RTH}$			+50	mV <sub>DC</sub>	
	CML Differential Input Low Threshold	$V_{RTL}$	-50			mV <sub>DC</sub>	
V-by-one	CML Common mode Bias Voltage	$V_{RCT}$		0		$V_{DC}$	
Interface	Intra-pair skew	TINTRA		1	0.3	UI	3
	Inter-pair skew	TINTER			5	UI	4
		A_X		0.25		UI	
		A_Y		0		mV	
		B_X		0.3		UI	
		B_Y		50		mV	
		C_X		0.7		UI	
		C_Y		50		mV	
	Eve discourse at as a sive	D_X		0.75		UI	_
	Eye diagram at receiver	D_Y		0		mV	5
		E_X		0.7		UI	]
		E_Y		-50		mV	
		F_X		0.3		UI	
		F_Y		-50		mV	



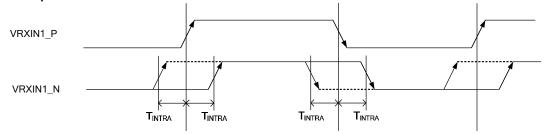
### 1. V-by-One Signal diagram



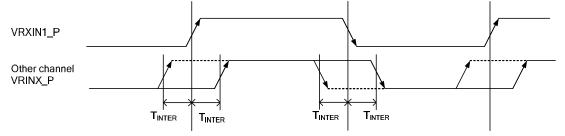
2. Receiver Clock SSCG (Spread spectrum clock generator) is defined as below figures.



### 3. V-by-One Intra-pair Skew

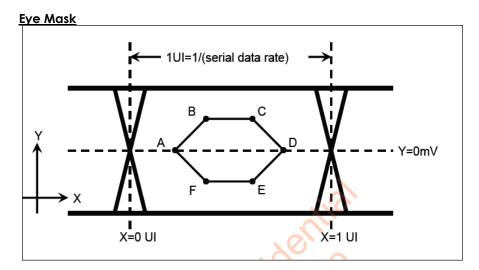


### 4. V-by-One Inter-pair Skew



### 5. Eye diagram at receiver





**Example of Eye diagram** 





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# 3.4.5 Input Timing Specification

It only support DE mode, and the input timing are shown as the following table.

Symbol	Descrip	tion	Min.	Тур.	Max.	Unit	Remark
Tv		Period	1100	1671	5580	Th	
Tdisp (v)	Vertical Section	Active	1080	1080	1080	Th	
Tblk (v)	vomedroeenen	Blanking	20	591	4500	Th	
Fv		Frequency	30	120	144	Hz	
Th		Period	269	270	511	Tclk	
Tdisp (h)	Horizontal	Active	240	240	240	Tclk	
Tblk (h)	Section	Blanking	29	30	271	Tclk	
Fh		Frequency	200.5	200.5	241.5	KHz	Note 3-3
Tclk	LVDS Clock	Period	15.4	18.5	18.5	ns	1/Fclk
Fclk	L V DO CIOCK	Frequency	54.0	54.1	65.0	MHz	Note 3-4

Note 3-3: Please don't exceed the above recommended value.

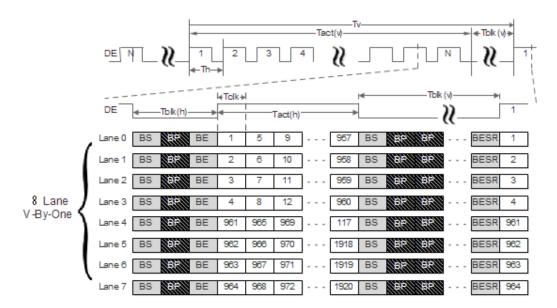
**Note 3-4:** The equation is listed as following. Please don't exceed the above recommended value.

Fclk (Typ.) = Fv (Typ.) x Th (Typ.) x Tv (Typ.);

Fclk (Min.) < Fv x Th x Tv < Fclk (Max.)

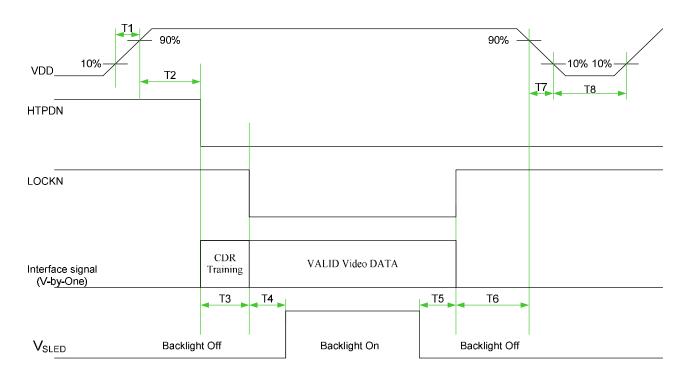


## 3.4.6 Input Timing Diagram



### 3.5 Power ON/OFF Sequence

VDD power,V-by-One signal and backlight on/off sequence are as following. V-by-One signals from any system shall be Hi-Z state when VDD is off.



### **Power Sequence Timing**

Symbol		Value	11 21	Remark			
Symbol	Min.	Тур.	Max.	Unit			
T1	0.5	-	10	[ms]			
T2	0	40	-	[ms]			
Т3	0	2	-	[ms]	Note 3-5		
T4	600	-	-	[ms]			
T5	100			[ms]			
T6	0	-	50	[ms]	Note 3-6 Note 3-7		
Т7	0	-	200	[ms]	Note 3-6 Note 3-8		
T8	1000	-	-	[ms]			

Note 3-5: During T3 period, V-by-One CDR training time by customer's system.

Note 3-6: During T6 and T7 period, please keep the level of input V-by-One signals with Hi-Z state.

**Note 3-7:** Recommend setting T6 = 0ms to avoid electronic noise when VDD is off.

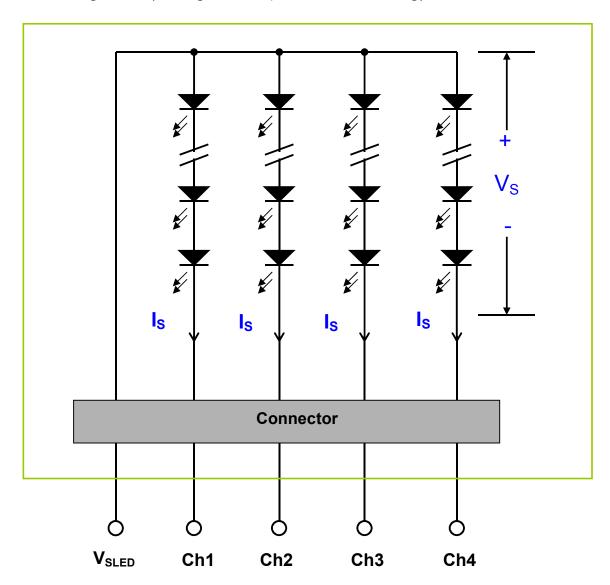
Note 3-8: Voltage of VDD must decay smoothly after power-off. (customer syster decide this value)



# 4 Backlight Unit

# 4.1 Block Diagram

The following shows the block diagram of the 27 inch Backlight Unit. And it includes 72 pcs LED in the LED light bar. (4 strings and 18 pcs LED of one string).





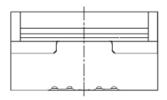
### **4.2 Interface Connection**

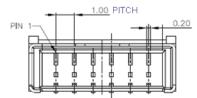
## 4.2.1 Connector Type

Backlight Connector	Manufacturer	CviLux				
Buoking it Connector	Part Number	CI1406M1VLD-NH				
Mating Congression	Manufacturer	CviLux				
Mating Connector	Part Number	CI1406SL000-NH(Lock)				

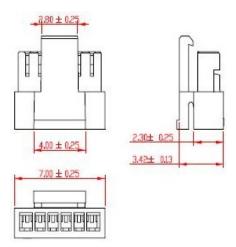
# **Backlight Connector dimension:**

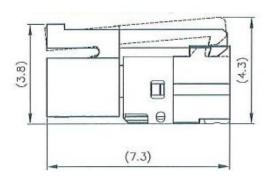
 $H \times V \times D = 13.9 \times 3.00 \times 4.25, Pitch = 1.0(unit = mm)$ 





# **Mating Connector dimension:**

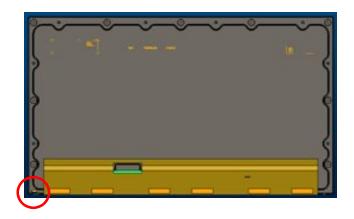


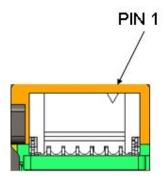




# 4.2.2 Connector Pin Assignment

Pin#	Symbol	Description	Remark
1	Ch1	LED Current Feedback Terminal (Channel 1)	
2	Ch2	LED Current Feedback Terminal (Channel 2)	
3	$V_{SLED}$	LED Power Supply Voltage Input Terminal	
4	$V_{SLED}$	LED Power Supply Voltage Input Terminal	
5	Ch3	LED Current Feedback Terminal (Channel 3)	
6	Ch4	LED Current Feedback Terminal (Channel 4)	







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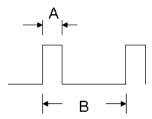
### 4.3 Electrical Characteristics

## 4.3.1 Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

(Ta=25°C)

Symbol	Description	Min	Max	Unit	Remark
			150	[mA]	100% duty ratio
Is	LED String Current	0	300	[mA]	Duty ratio ≦ 10% Pulse time=10 ms



Duty ratio= (A / B) X 100%; (A: Pulse time, B: Period)

# 4.3.2 Recommended Operating Condition

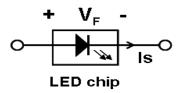
(Ta=25°C)

Symbol	Description	Min.	Тур.	Max.	Unit	Remark
Is	LED String Current	-	80	88	[mA]	100% duty ratio of LED chip, <b>Note 4-6</b>
Vs	LED String Voltage	48.6	54	59.4	[Volt]	Is=80mA @ 100% duty ratio; <b>Note 4-1, Note</b> <b>4-5, Note 4-7</b>
ΔVs	Maximum Vs Voltage Deviation of light bar	-	-	3.6	[Volt]	ls=80mA @ 100% duty ratio; <b>Note 4-2</b>
P <sub>BLU</sub>	LED Light Bar Power Consumption	-	17.3	19.0	[Watt]	Note 4-3
LT <sub>LED</sub>	LED Life Time	30,000	-	_	[Hour]	Note 4-4
OVP	Over Voltage Protection in system board	110% Vsmax	-	-	[Volt]	Note 4-5



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- **Note 4-1:** Vs (Typ.) =  $V_F$  (Typ.) X LED No. (one string);
  - a. V<sub>F</sub>: LED chip forward voltage, V<sub>F</sub> (Min.)=2.7V, V<sub>F</sub>(Typ.)=3.0V, V<sub>F</sub>(Max.)=3.3V
  - b. The same eugation to calculate Vs(Min.) & Vs (Max.) for respective V<sub>F</sub> (Min.)
  - & V<sub>F</sub>(Max.);



- **Note 4-2:**  $\Delta Vs$  (Max.) =  $\Delta V_F X$  LED No. (one string);
  - a.  $\Delta V_{F}$ : LED chip forward voltage deviation; (0.2 V, each Bin of LED  $V_{F}$ )
- **Note 4-3:**  $P_{BLU}$  (Typ.) = Vs (Typ.) X Is (Typ.) X 4; ( 4 is total String No. of LED Light bar)  $P_{BLU}$  (Max.) = Vs (Max.) X Is (Typ.) X 4;
- **Note 4-4:** Definition of life time:
  - a. Brightness of LED becomes to 50% of its original value
  - b. Test condition: Is = 80mA and 25°C (Room Temperature)
- **Note 4-5:** Recommendation for LED driver power design:

Due to there are electrical property deviation in LED & monitor set system component after long time operation. AUO strongly recommend the design value of LED driver board OVP (over voltage protection) should be 10% higher than max. value of LED string voltage (Vs) at least.

- **Note 4-6:** AUO strongly recommend "Analog Dimming" method for backlight brightness control for Wavy Noise Free. Otherwise, recommend that Dimming Control Signal (PWM Signal) should be synchronized with Frame Frequency.
- **Note 4-7**: Ensure that the LED light bar is not subjected either forward or reverse voltage while monitor set is on standby mode or not in use.



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### **5 Reliability Test**

AUO reliability test items are listed as following table. (Bare Panel only)

Items	Condition	Remark
Temperature Humidity Bias (THB)	Ta= 50°C , 80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50°C , 50%RH, 300hours	
Low Temperature Operation	Ta= 0°C , 300hours	
High Temperature Storage (HTS)	Ta= 60°C , 300hours	
Low Temperature Storage (LTS)	Ta= -20°C , 300hours	
Vibration Test (Non-operation)	Acceleration: 1.5 Grms Wave: Random Frequency: 10 - 200 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 20 ms Direction: ±X, ±Y, ±Z (one time for each Axis)	
Thermal Shock Test (TST)	-20°C/30min, 60°C/30min, 100 cycles	Note 5-1
On/Off Test	On/10sec, Off/10sec, 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: $\pm$ 15KV, 150pF(330 $\Omega$ ) 1sec, 8 points, 25 times/ point.	Note 5-2
ESD (Electro Static Discharge)	Air Discharge: $\pm$ 15KV, 150pF(330 $\Omega$ ) 1sec 8 points, 25 times/ point.	
Altitude Test	Operation:18,000 ft Non-Operation:40,000 ft	

- **Note 5-1**: a. A cycle of rapid temperature change consists of varying the temperature from  $-20^{\circ}$  to  $60^{\circ}$ , and back again. Power is not applied during the test.
  - b. After finish temperature cycling, the unit is placed in normal room ambient for at least 4 hours before power on.

Note 5-2: EN61000-4-2, ESD class B: Certain performance degradation allowed

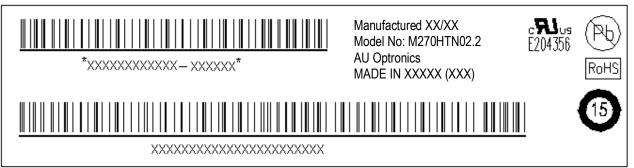
No data lost Self-recoverable No hardware failures.

Note5-3: Result Evaluation Criteria:

TFT-LCD panels test should take place after gradually cooling enough at room temperature In the normal application, there should be no particular problems that may affect the display function.

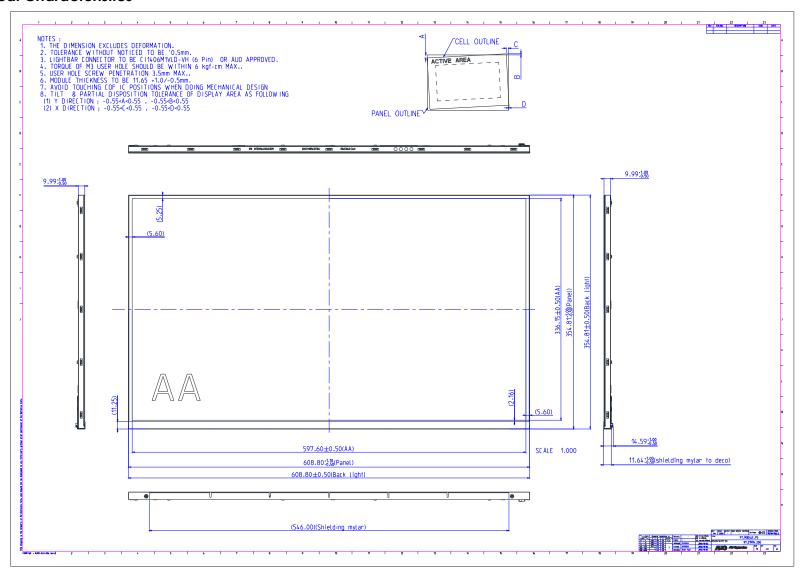
# 6 Shipping Label

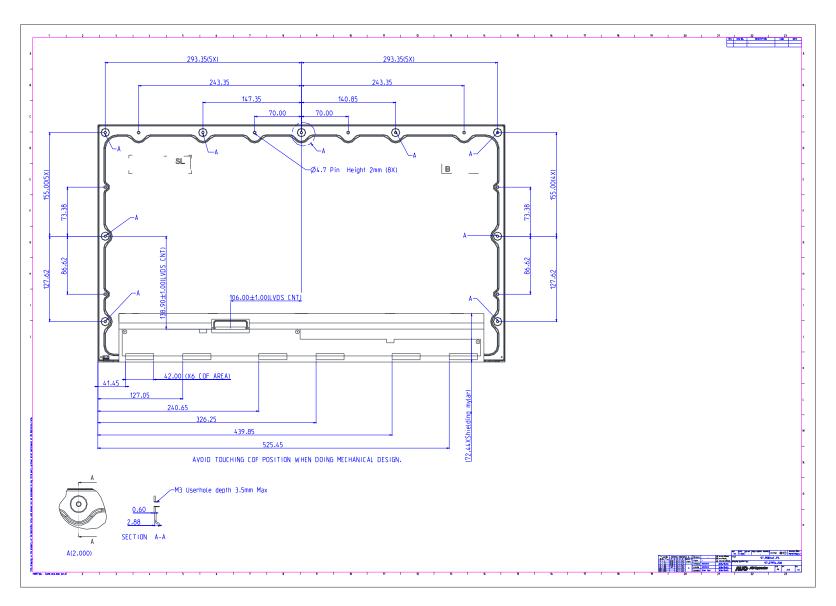
The label is on the panel as shown below:



- Note 6-1: For Pb Free products, AUO will add (%) for identification.
- Note 6-2: For RoHS compatible products, AUO will add RoHS for identification.
- Note 6-3: For China RoHS compatible products, AUO will add 15 for identification.
- **Note 6-4:** The Green Mark will be presented only when the green documents have been ready by AUO Internal Green Team.

### 7 Mechanical Characteristics

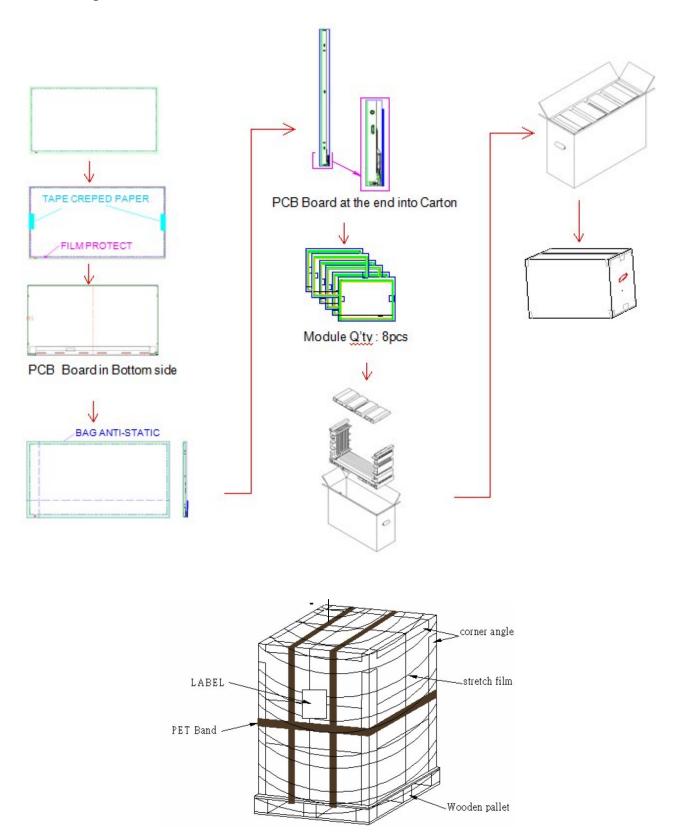




- (1) Avoid touching COF position when doing mechanical design
- (2) The user hole depth of the light bar side is different from the other side

# **8 Packing Specification**

# 8.1 Packing Flow



8.2 Pallet and shipment information

Item		Remark		
nem	Q'ty	Dimension	Weight(kg)	Kemark
Panel	1	608.8(H)mm × 354.8(V)mm × 11.645(D)mm	3.22	
Cushion	1	•	1.7	
Вох	1	702(L)mm x 264(W)mm x 456(H)mm	1.2	without Panel & cushion
Packing Box	8 pcs/Box	702(L)mm x 264(W)mm x 456(H)mm	28.66	with panel & cushion & Box
Pallet	1	1070(L)mm x 740(W)mm x 132(H)mm	14.80	
Pallet after Packing	8 boxes/pallet	1070(L)mm x 740(W)mm x 1086(H)mm	244.08	